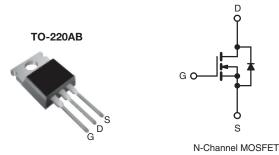


**Vishay Siliconix** 

### Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.028		
Q <sub>g</sub> (Max.) (nC)	67			
Q <sub>gs</sub> (nC)	18			
Q <sub>gd</sub> (nC)	25			
Configuration	Single			



#### **FEATURES**

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universially preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFZ40PbF
	SiHFZ40-E3
SnPb	IRFZ40
	SiHFZ40

ABSOLUTE MAXIMUM RATINGS (T <sub>c</sub> = 25 °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V <sub>DS</sub>	60	V		
Gate-Source Voltage			V <sub>GS</sub>	± 20	v		
Continuous Drain Current <sup>e</sup>	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	50			
Continuous Drain Current		T <sub>C</sub> = 100 °C		36	А		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	200			
Linear Derating Factor				1.0	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	100	mJ		
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		PD	150	W		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	*0		
Soldering Recommendations (Peak Temperature) <sup>d</sup>	for 10 s			300	°C		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in		
				1.1	N·m		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 44 µH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 51 A (see fig. 12).

c.  $I_{SD} \leq 51$  A, dl/dt  $\leq 250$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C.

d. 1.6 mm from case.

e. Current limited by the package, (die current = 51 A).

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP. MAX.			UNIT				
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62 0.50 -							
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>				°C/W				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 1.0							
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)							
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 2	50 µA	60	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.060	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	50 µA	2.0	-	4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	/	-	-	± 100	nA	
Zero Gate Voltage Drain Current	1	V <sub>DS</sub>	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	25	μA	
	I <sub>DSS</sub>	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			-	-	250	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$		= 31 A <sup>b</sup>	-	-	0.028	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 25 V, I <sub>D</sub> =	31 A	15	-	-	S	
Dynamic		1			T	T	T		
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0  MHz,  see fig. 5		-	1900	-	pF		
Output Capacitance	C <sub>oss</sub>			-	920	-			
Reverse Transfer Capacitance	C <sub>rss</sub>			-	170	-			
Total Gate Charge	Qg			51 A, V <sub>DS</sub> = 48 V, ee fig. 6 and 13 <sup>b</sup>	-	-	67	nC	
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 V$	I <sub>D</sub> = 51 A see fig		-	-	18		
Gate-Drain Charge	Q <sub>gd</sub>				-	-	25		
Turn-On Delay Time	t <sub>d(on)</sub>				-	14	-		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $I_D$ = 51 A, $R_g$ = 9.1 $\Omega,~R_D$ = 0.55 $\Omega,$ see fig. $10^{\rm b}$		-	110	-	ns		
Turn-Off Delay Time	t <sub>d(off)</sub>			-	45	-			
Fall Time	t <sub>f</sub>			-	92	-			
Internal Drain Inductance	L <sub>D</sub>	Between lead 6 mm (0.25")	Between lead,		-	4.5	-		
Internal Source Inductance	Ls	package and center of die contact		-	7.5	-	nH		
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50	A		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	200			
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = 51 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.5	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 51 A, dl/dt = 100 A/μs		-	120	180	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.53	0.80	nC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by				v Le and	Ln)		

#### Notes

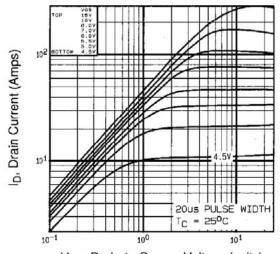
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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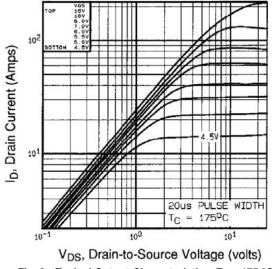


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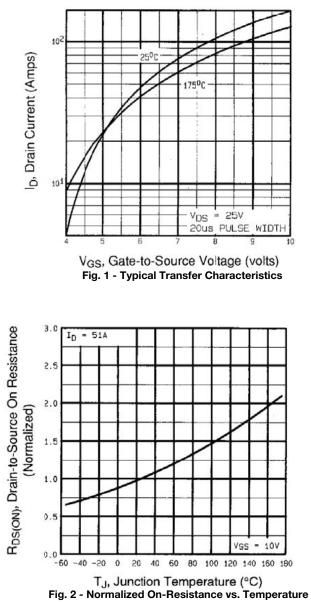


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)









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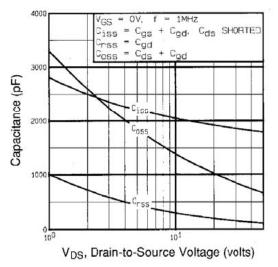


Fig. 3 - Typical Capacitance vs. Drain-to-Source Voltage

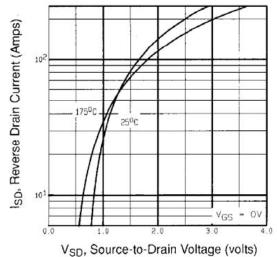


Fig. 5 - Typical Source-Drain Diode Forward Voltage

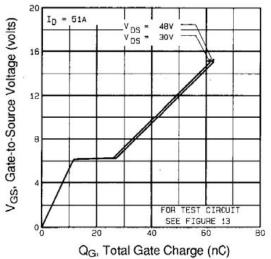
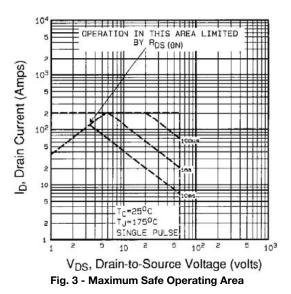


Fig. 4 - Typical Gate Charge vs. Gate-to-Source Voltage



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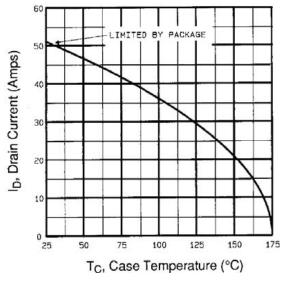


Fig. 9 - Maximum Drain Current vs. Case Temperature

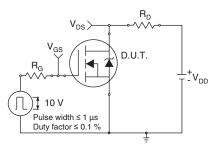


Fig. 10a - Switching Time Test Circuit

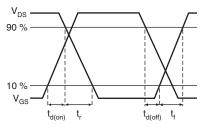
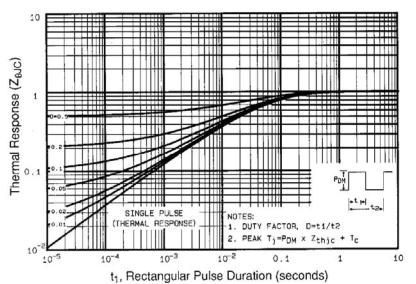


Fig. 10b - Switching Time Waveforms





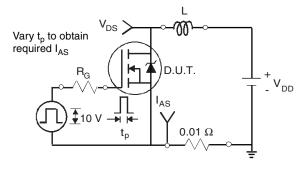
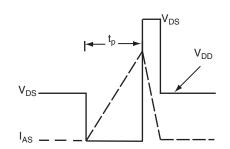
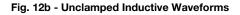


Fig. 12a - Unclamped Inductive Test Circuit





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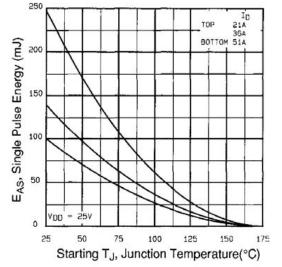


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

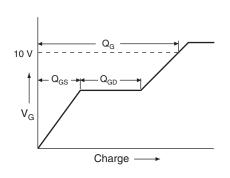


Fig. 13a - Basic Gate Charge Waveform

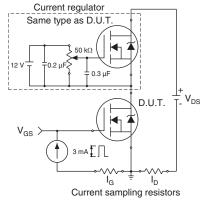
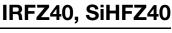


Fig. 13b - Gate Charge Test

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#### Peak Diode Recovery dV/dt Test Circuit

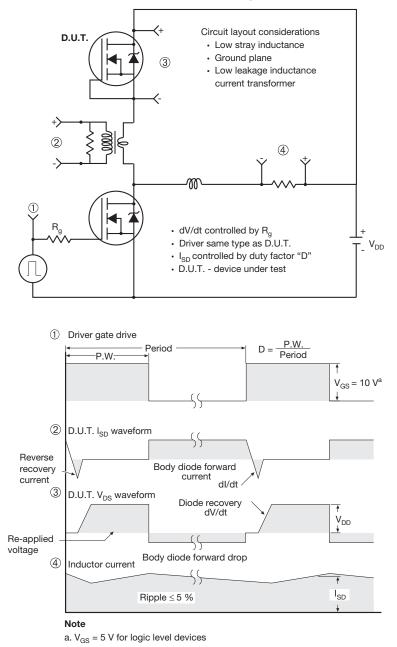


Fig. 14 - For N-Channel

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